

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:	)
Gunther et al.	)
Serial No.: 09/784,255	)
Filed: February 14, 2001	)
For: Methods and Apparatus for Thermal Management of an Integrated Circuit Die	)
Examiner: T. S. Lau	)
Group Art Unit: 2863	)
Docket No.: P4728X	)
	) )

Mail Stop AF Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

## **AMENDMENT**

Sir:

This amendment is submitted in accordance with 37 C.F.R. § 1.111 in

response to a non-final office action.

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage in an envelope addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313 on:

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Signa

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Serial No. 09/784,255 Docket No. P4728X

## **INTRODUCTORY COMMENTS**

The following amendments and remarks are proposed in response to the Final Office Action mailed January 23, 2004.

Claims 1-27, 31-40, and 49 are currently pending in the application. Claims 1, 6-9, 14, 16, 17, 22, 24, and 37-40 stand rejected, and claims 2-5, 10-13, 15, 18-21, and 23 stand objected to. Claims 25-27, 31-36, and 49 have been allowed. Applicants propose herein to amend claims 1, 3, 4, 5, 9, 11, 12, 13, 17, 19, 20, and 21. Applicants also propose to cancel claims 2, 10, 18, and 37-40, without prejudice.

Applicants respectfully request reconsideration of the application in view of the amendments set forth herein and the accompanying remarks below.